



Material Content Data Sheet



Sales Product Name		IPD65R950C6		Issued		19. July 2018		
MA#		MA001136132						
Package		PG-TO252-3-313		Weight*		318.37 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.509	0.79	0.79	7881	7881
leadframe	non noble metal	iron	7439-89-6	0.147	0.05		463	
	inorganic material	phosphorus	7723-14-0	0.044	0.01		139	
	non noble metal	copper	7440-50-8	147.096	46.20	46.26	462029	462631
wire	non noble metal	aluminium	7429-90-5	0.509	0.16	0.16	1600	1600
encapsulation	organic material	carbon black	1333-86-4	1.412	0.44		4434	
	plastics	epoxy resin	-	24.706	7.76		77602	
	inorganic material	silicondioxide	60676-86-0	115.060	36.14	44.34	361404	443440
leadfinish	non noble metal	tin	7440-31-5	3.740	1.17	1.17	11747	11747
plating	inorganic material	phosphorus	7723-14-0	0.003	0.00		11	
	non noble metal	nickel	7440-02-0	1.421	0.45	0.45	4462	4473
solder	noble metal	silver	7440-22-4	0.063	0.02		198	
	non noble metal	tin	7440-31-5	0.050	0.02		158	
	non noble metal	lead	7439-92-1	2.406	0.76	0.80	7558	7914
heatspreader	non noble metal	iron	7439-89-6	0.019	0.01		60	
	inorganic material	phosphorus	7723-14-0	0.006	0.00		18	
	non noble metal	copper	7440-50-8	19.177	6.02	6.03	60236	60314
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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